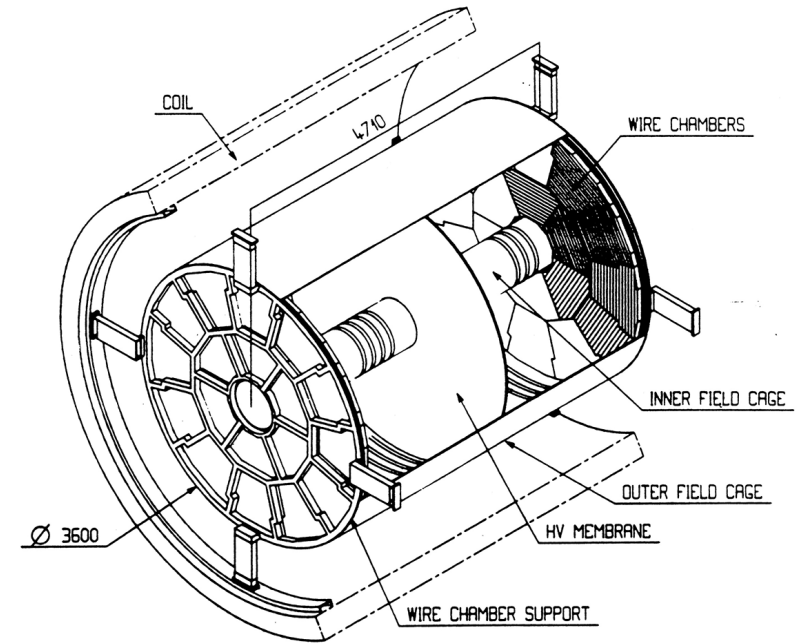


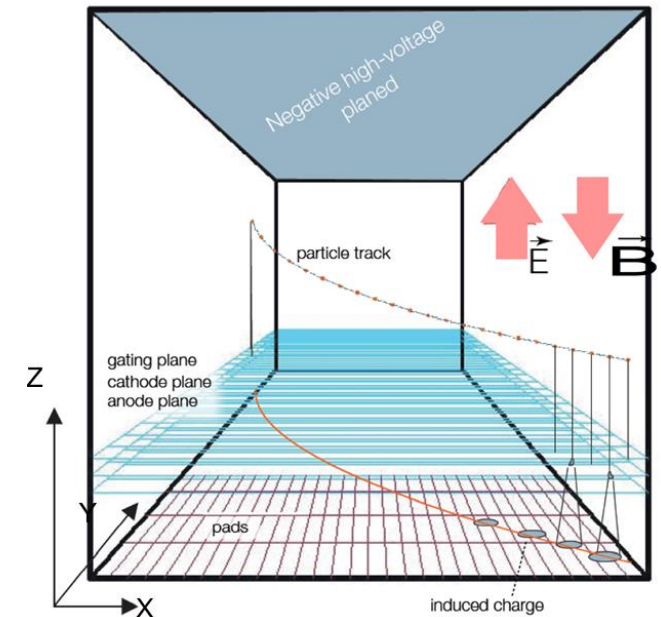
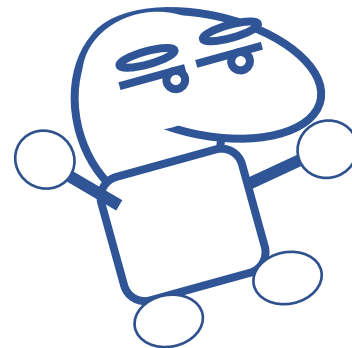
CERN-Korea summer student program

How to prevent ion backflow(IBF)? Gating grid and GEM



2024-07-12

Wonjun-Jeong



Introduce

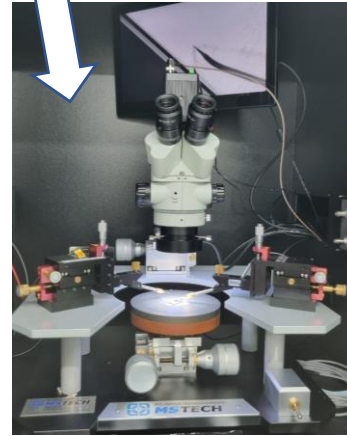


이름 : 정원준
소속 : 인하대
MBTI : INFJ
취미 : 영화

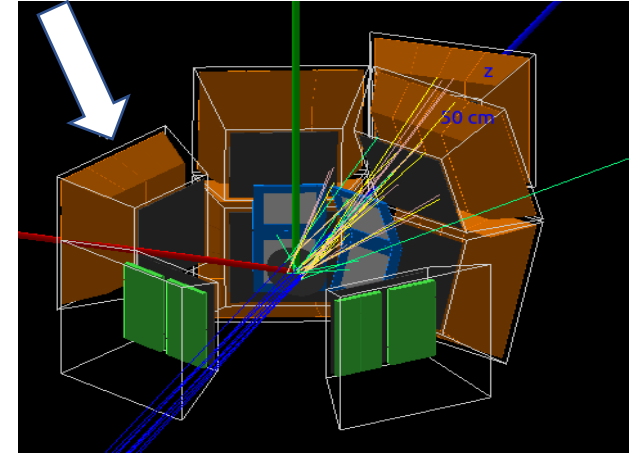
연구실에서 했던 일들

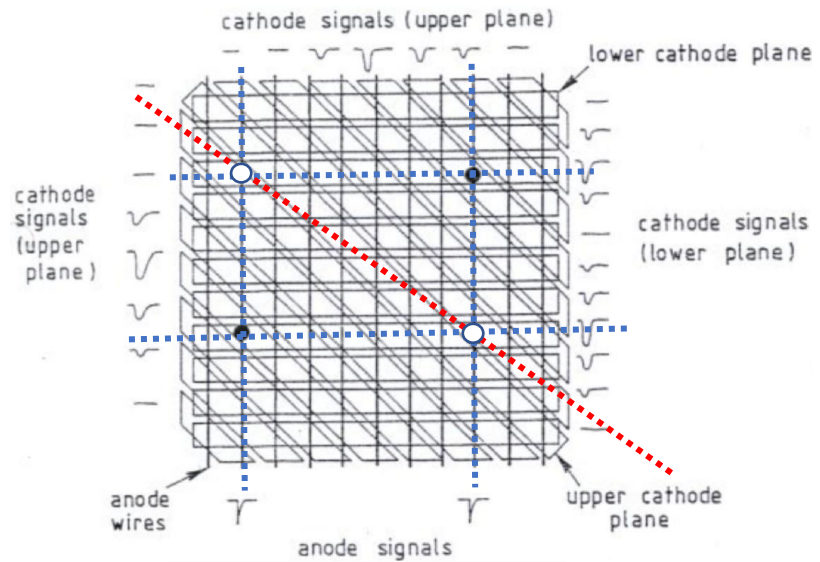


실리콘 칩 테스트

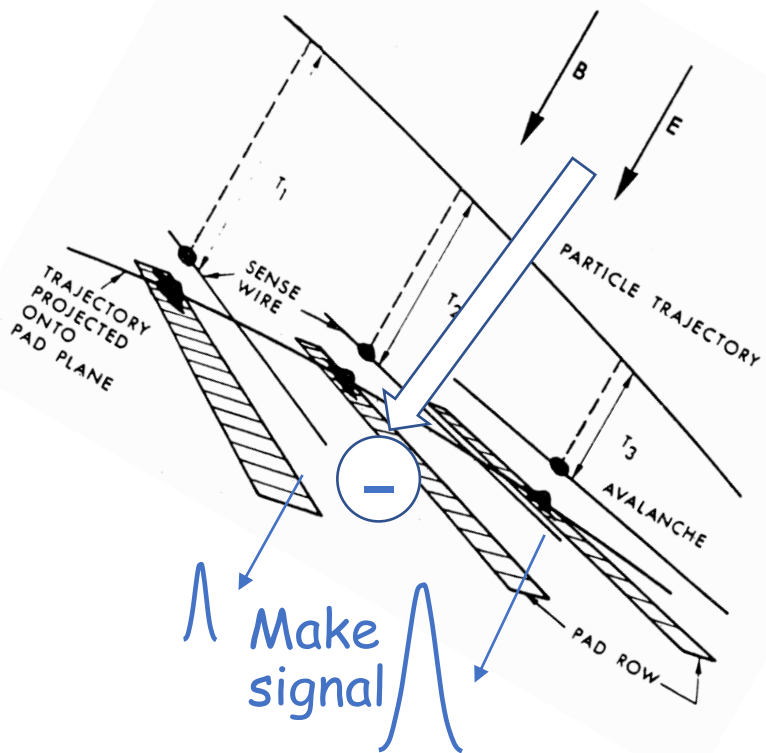
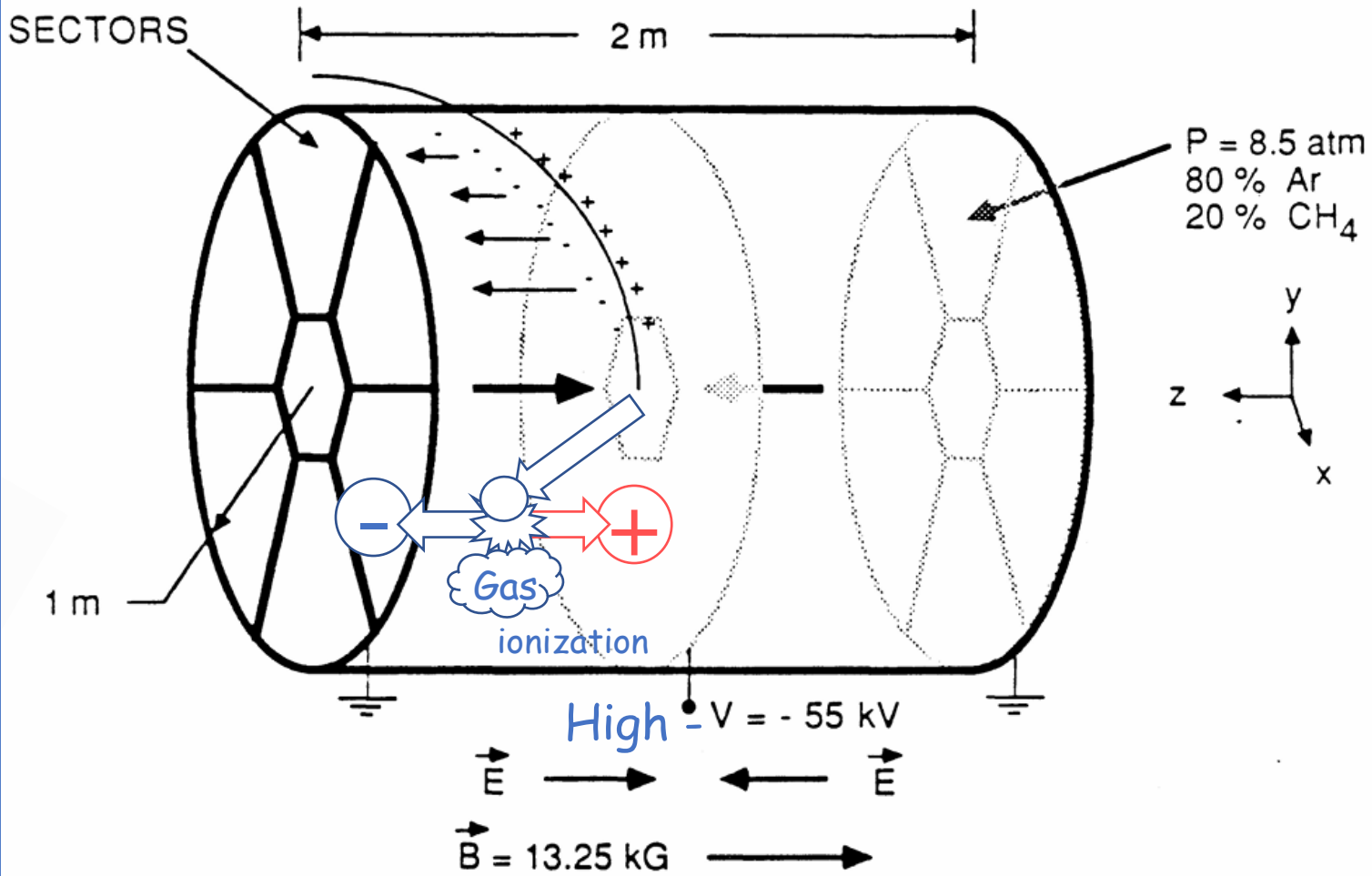


Nptool simulation

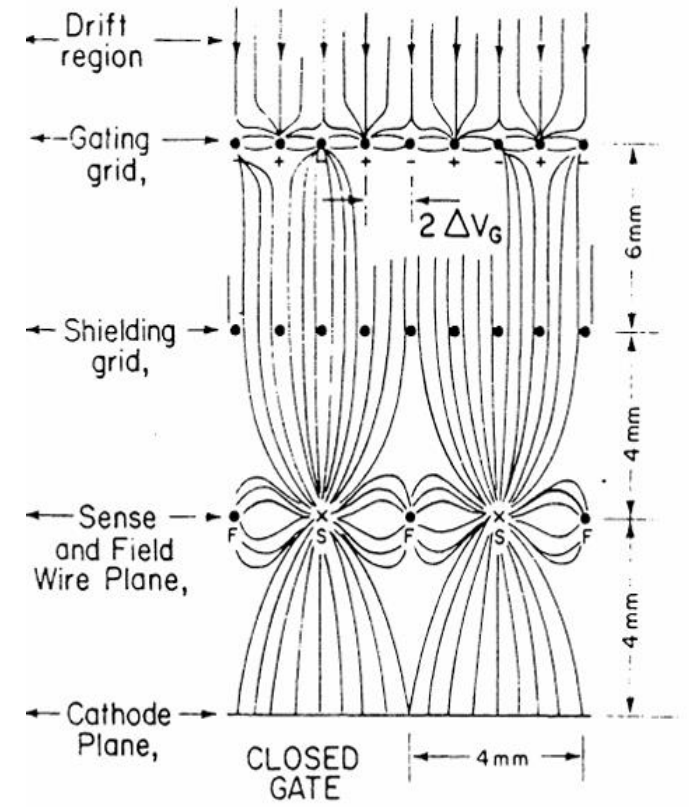
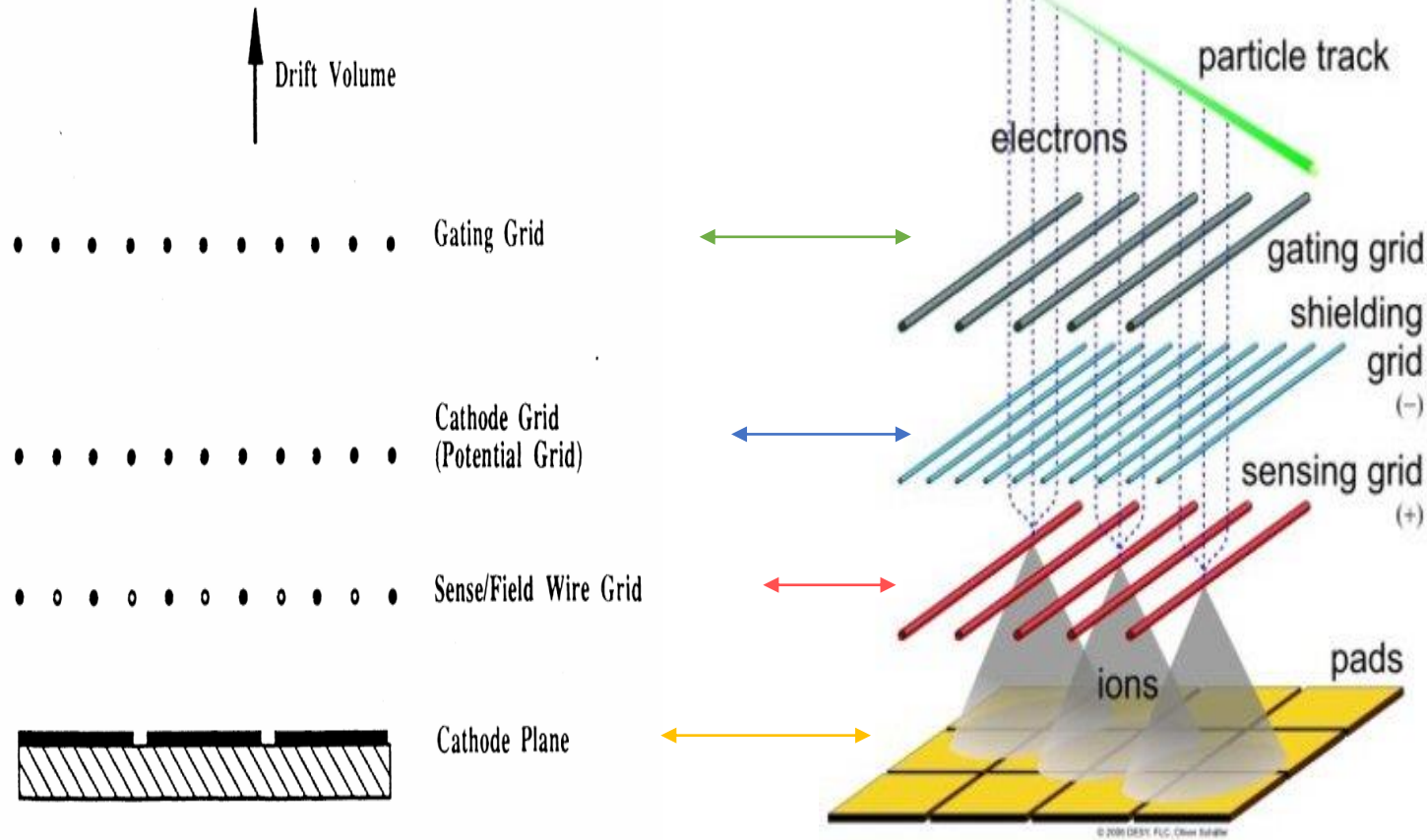




SECTORS

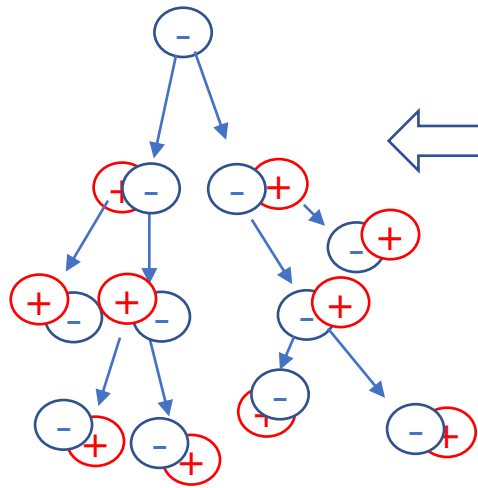


Wire Chamber

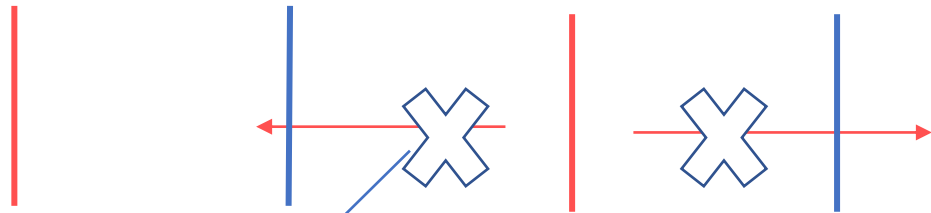
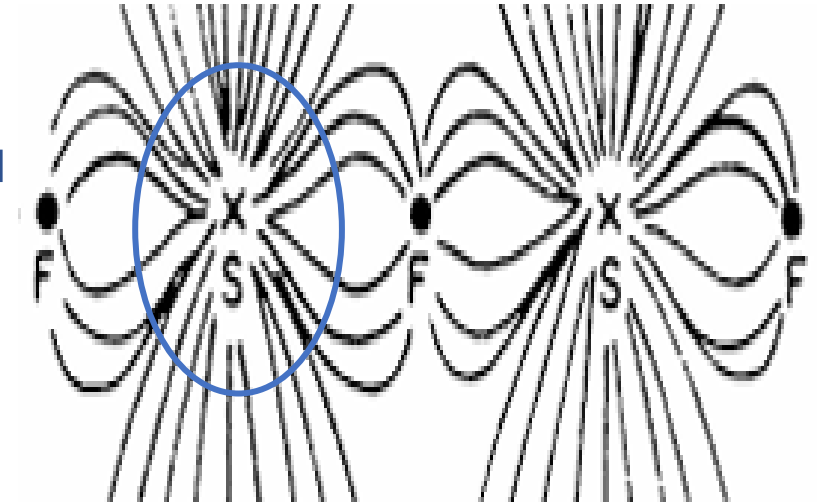


Wire Chamber

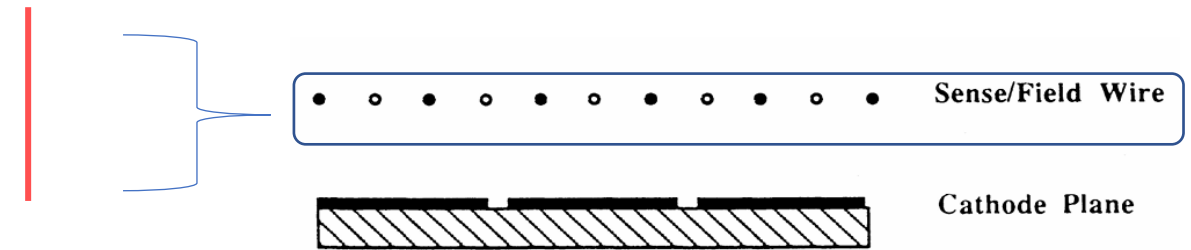
Avalanche effect



Strong \vec{E} \rightarrow strong Kinetic E



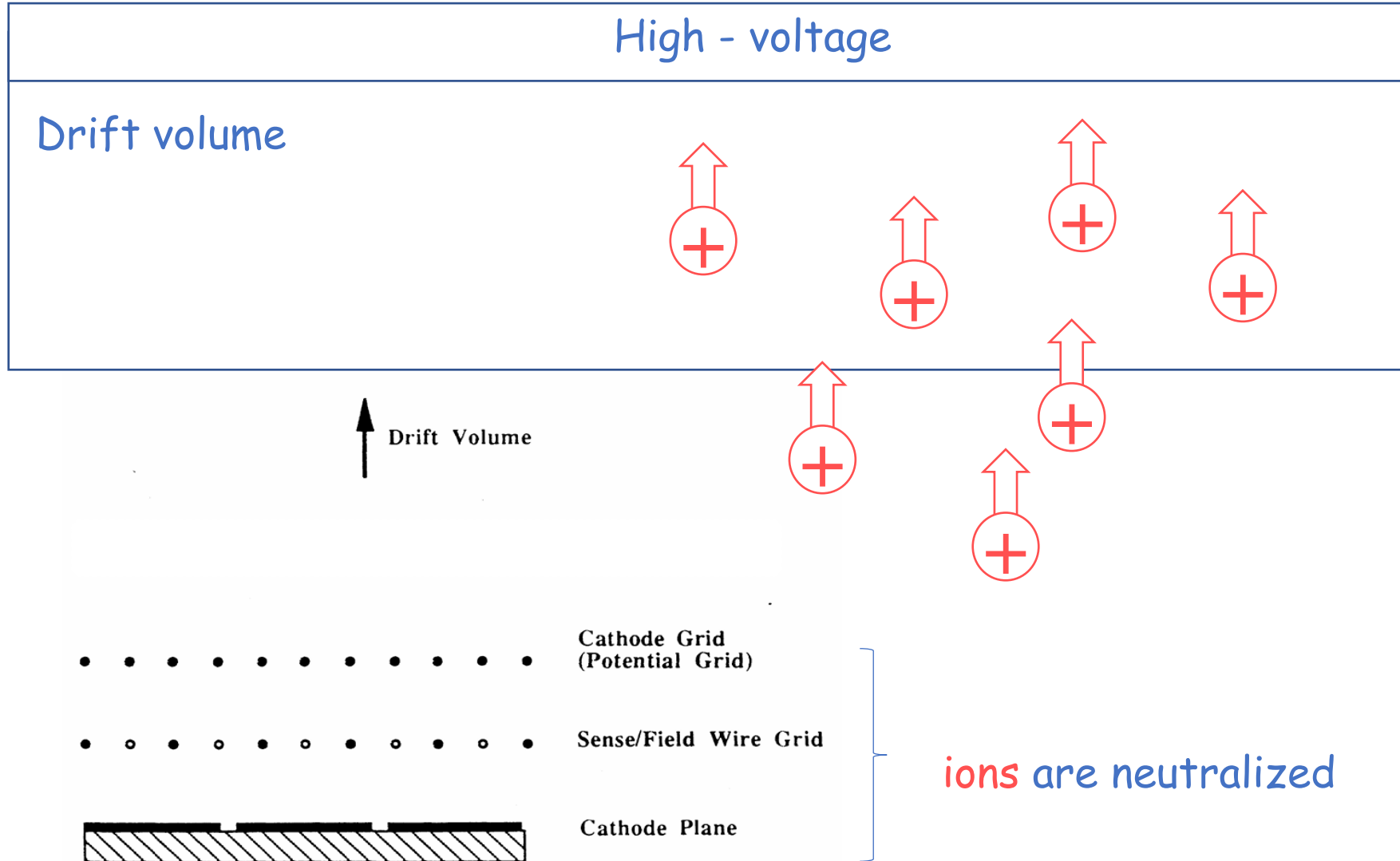
Using conducting barrier



Field wire \rightarrow electrically decouple the sense wire

Sense wire : anode wire (+)

Before Gating Grid



Ion Back Flow (IBF)

Ions stay here for a long time

Few ions go to HV plane (slowly)

ions are neutralized

Before Gating Grid

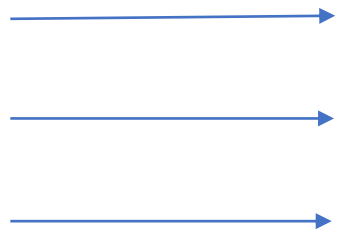
Uniformity of the electric field -> very important

$$\vec{v}_d \sim \vec{E}$$
$$t = l/v$$

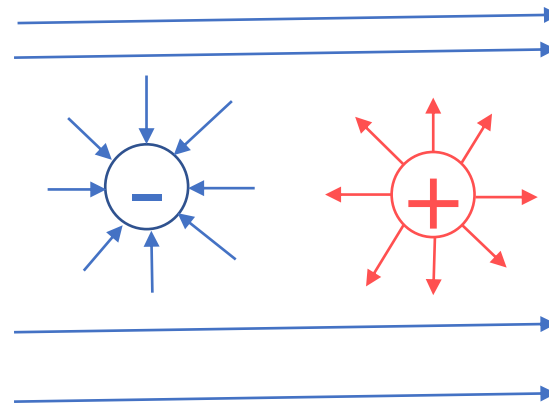
Detect t_d



Homogenous Electric field



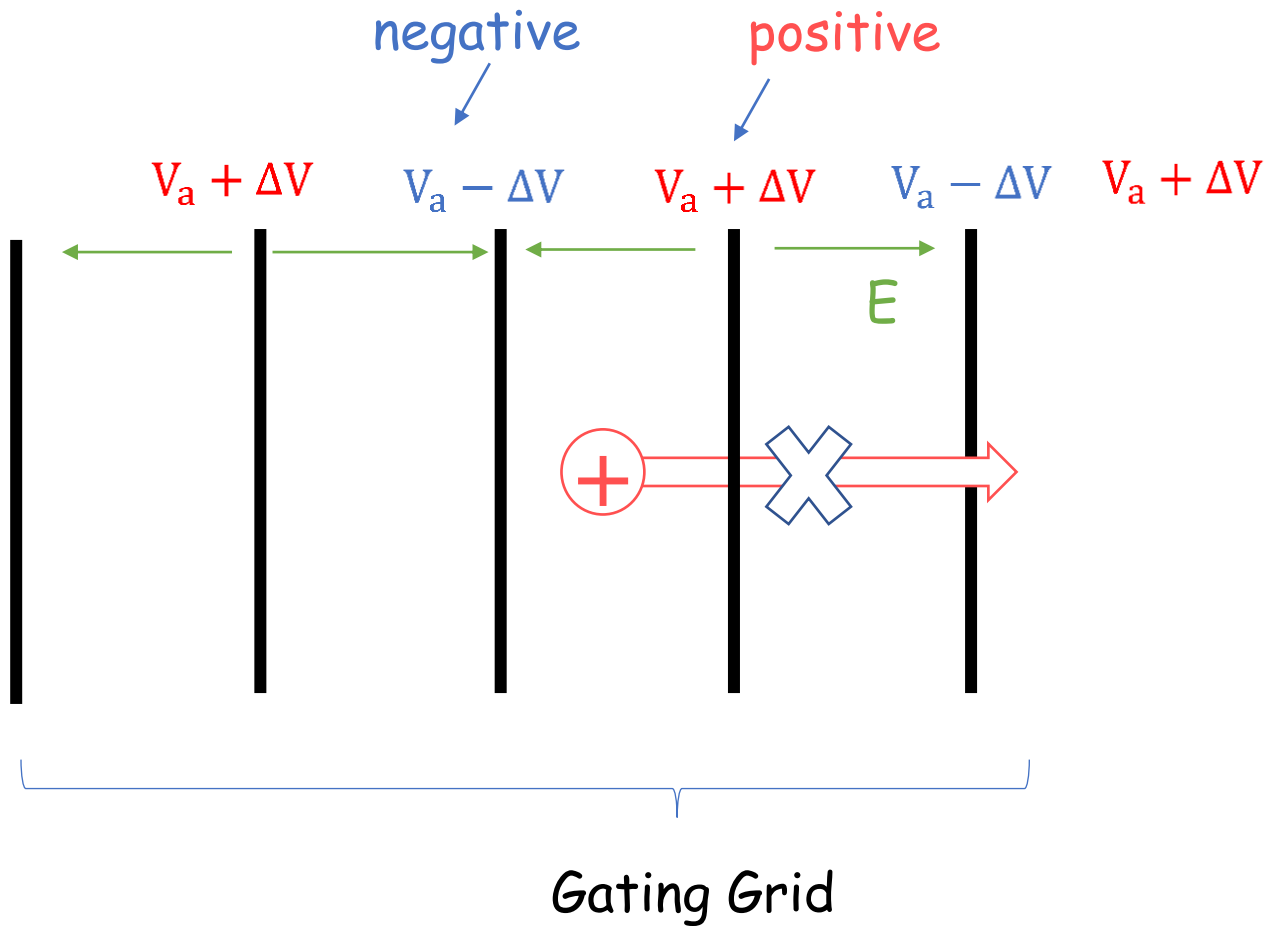
Ion Back Flow



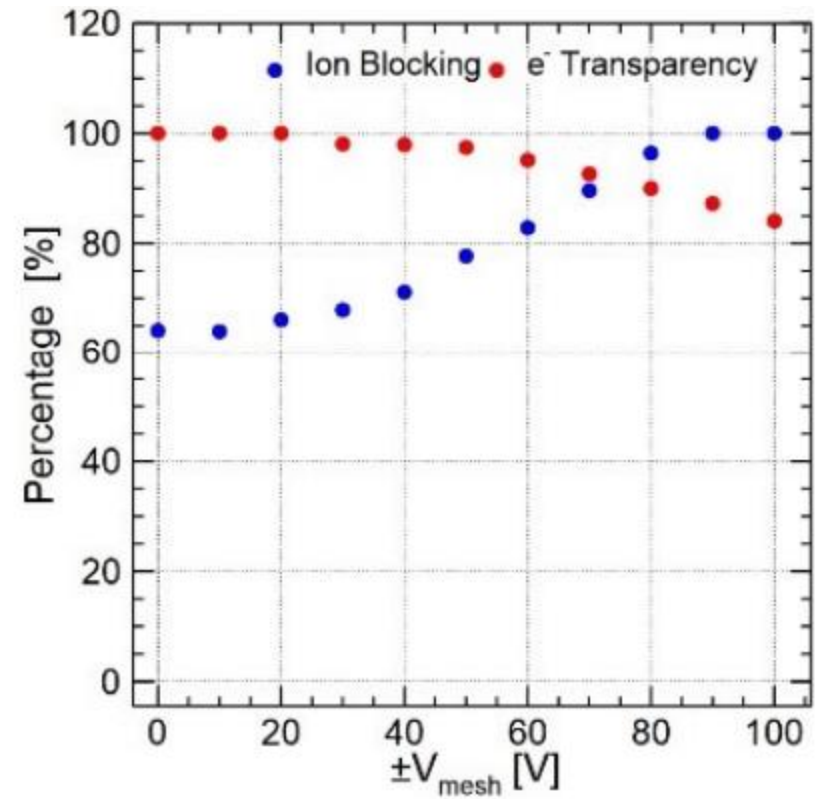
Still uniform?

(also near sense wire, Avalanche process make more positive ion)

Gating Grid

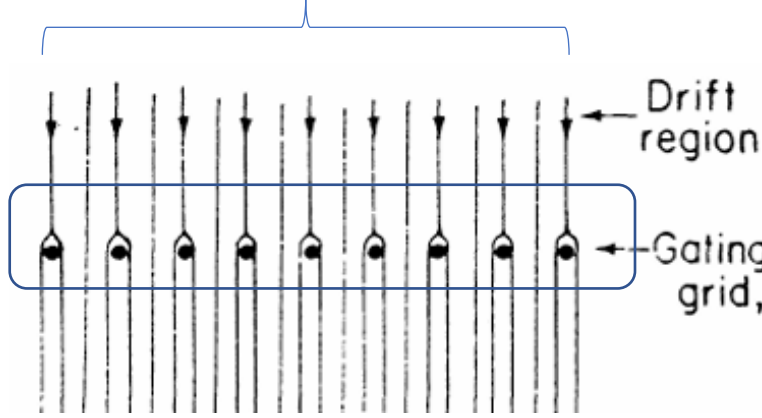


Big ΔV
transmittance $\rightarrow 0$
 $\Delta V \sim 50-100V$

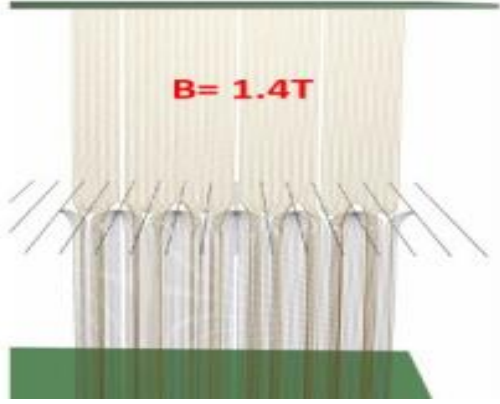
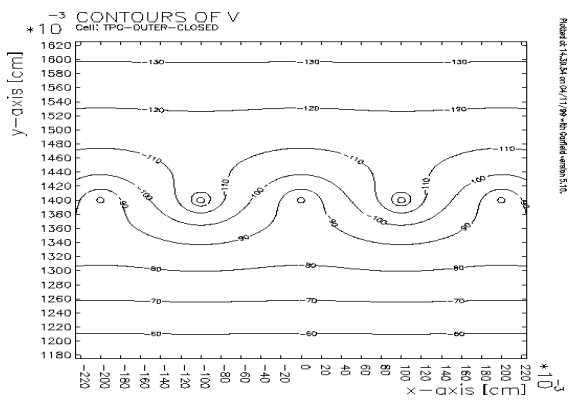
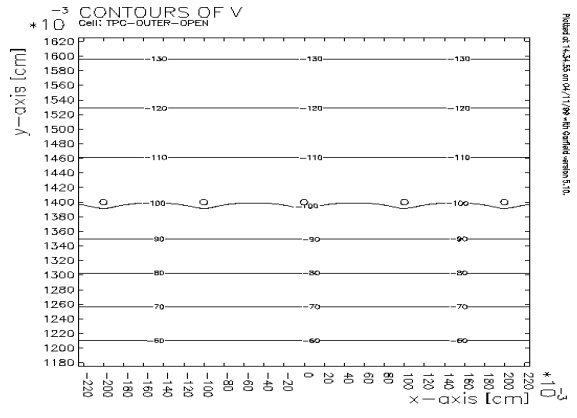
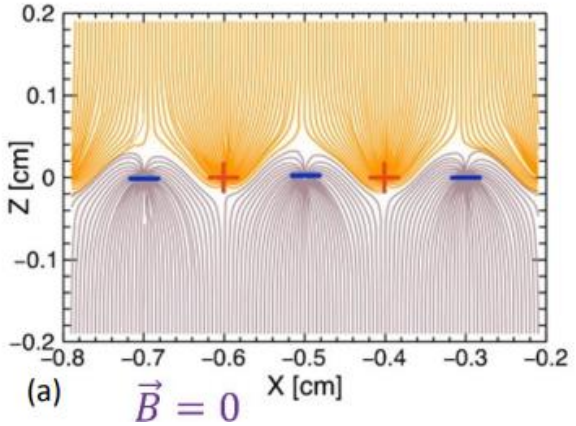
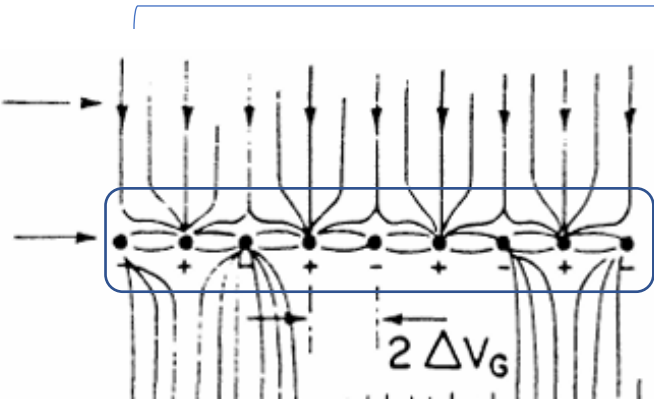


Gating Grid

Open gate

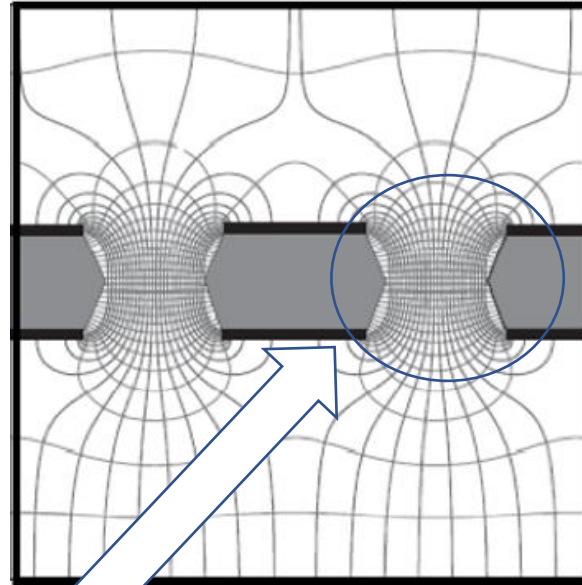
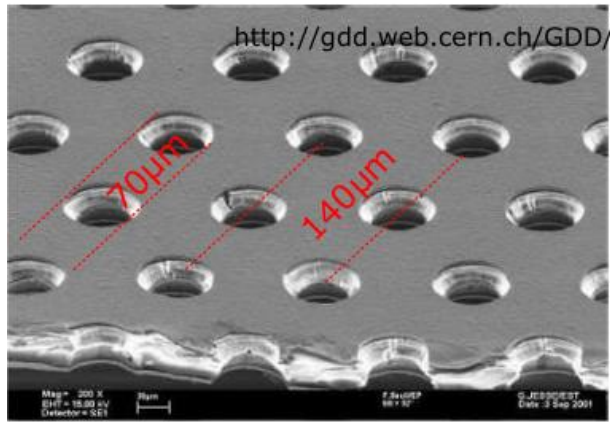


Closed gate

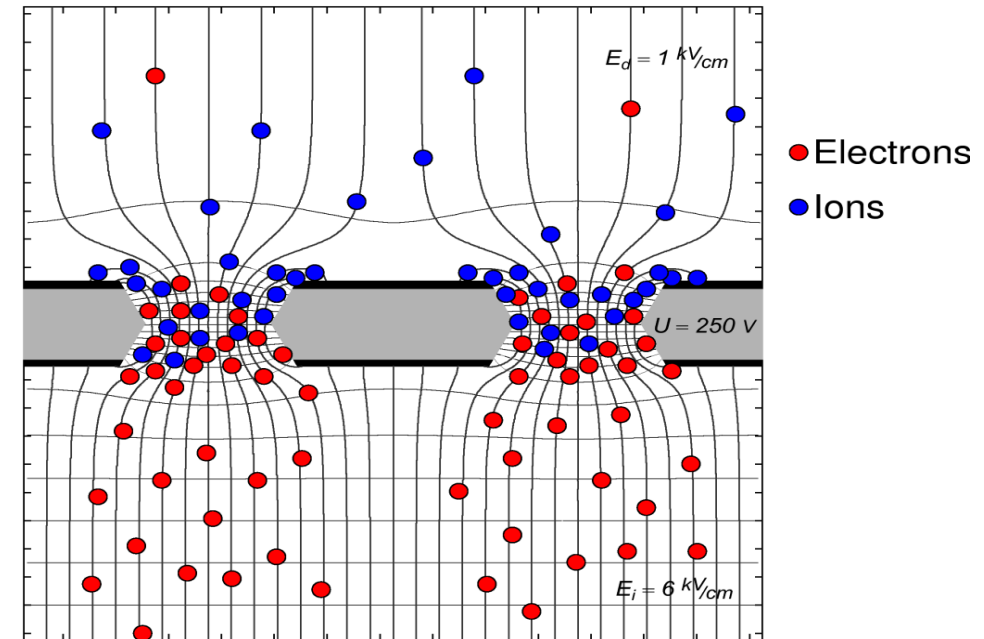
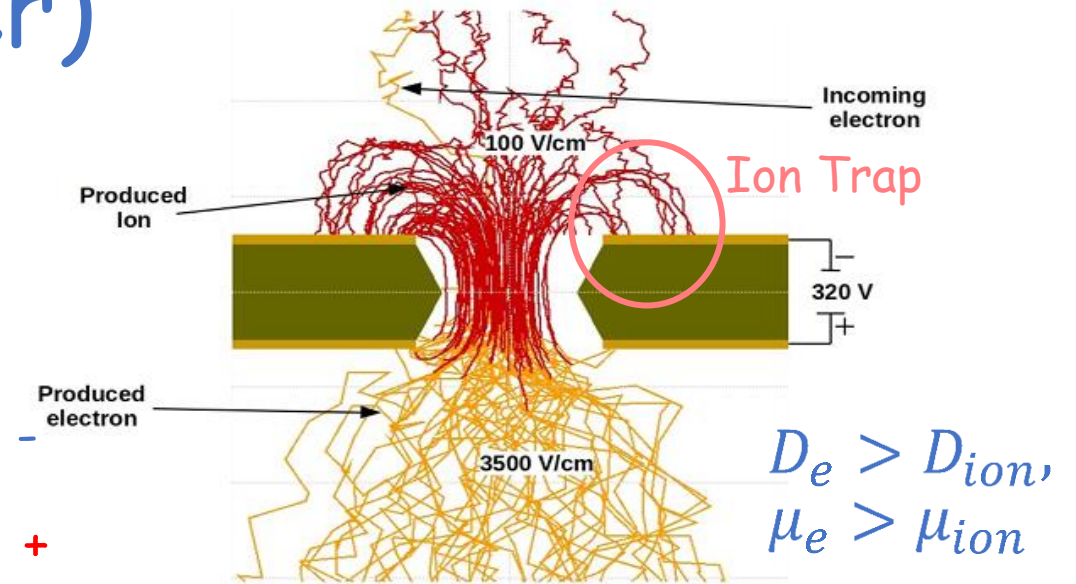
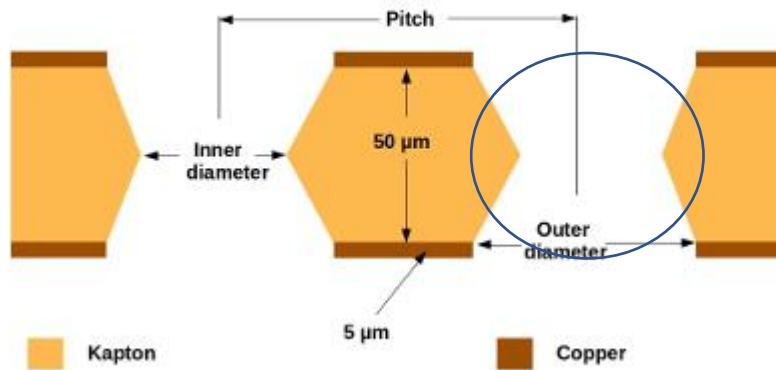


GEM(Gas Electron Multiplier)

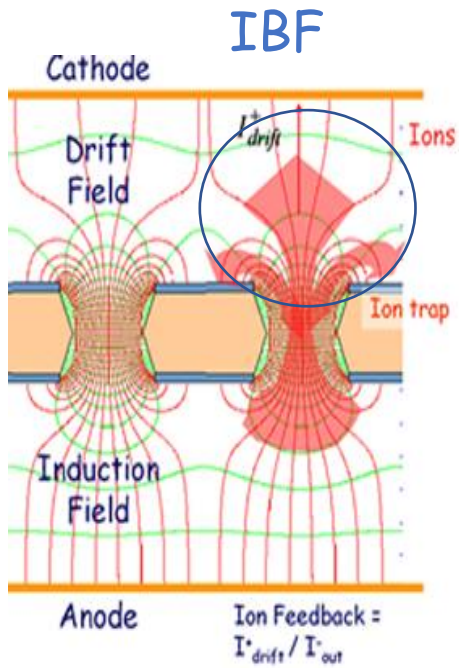
Copper coated Kapton foils



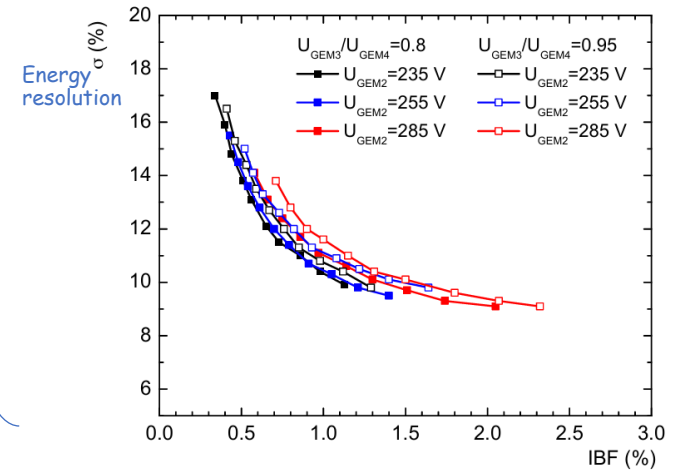
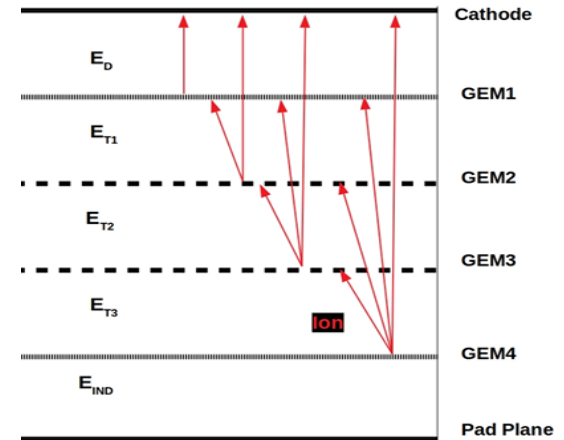
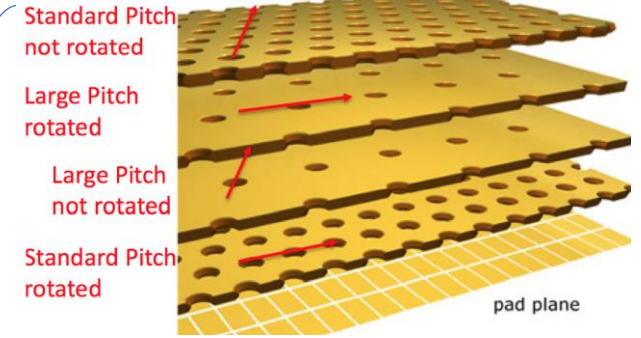
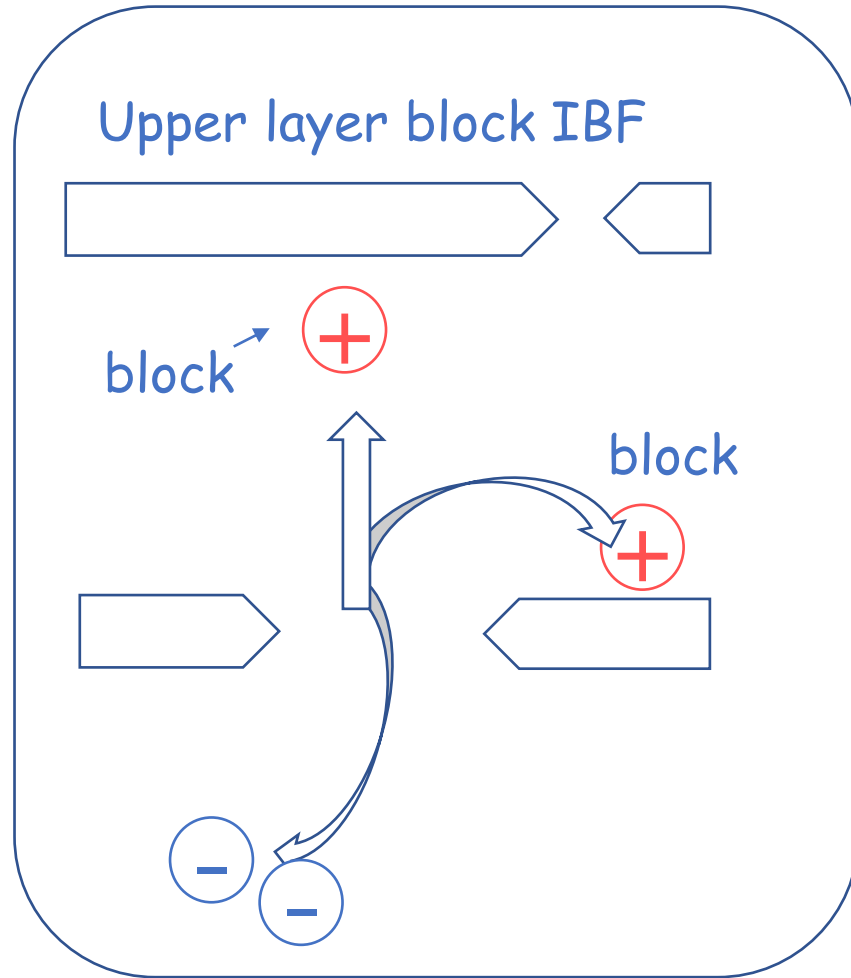
Field line focused in holes



GEM



Using multi Gem layer



Reference

The Time Projection Chamber, Thomas Lohse and Werner Witzeling (1978)

William R.Leo, Techniques for Nuclear and Particle Physics Experiments

Development of a gating driver of TPC for exotic beam experiments, J Yuan (2023)

Simulation of the electron and ion movement through a 4-GEM stack

Study of Passive Gating Grid for Ion Back Flow Suppression

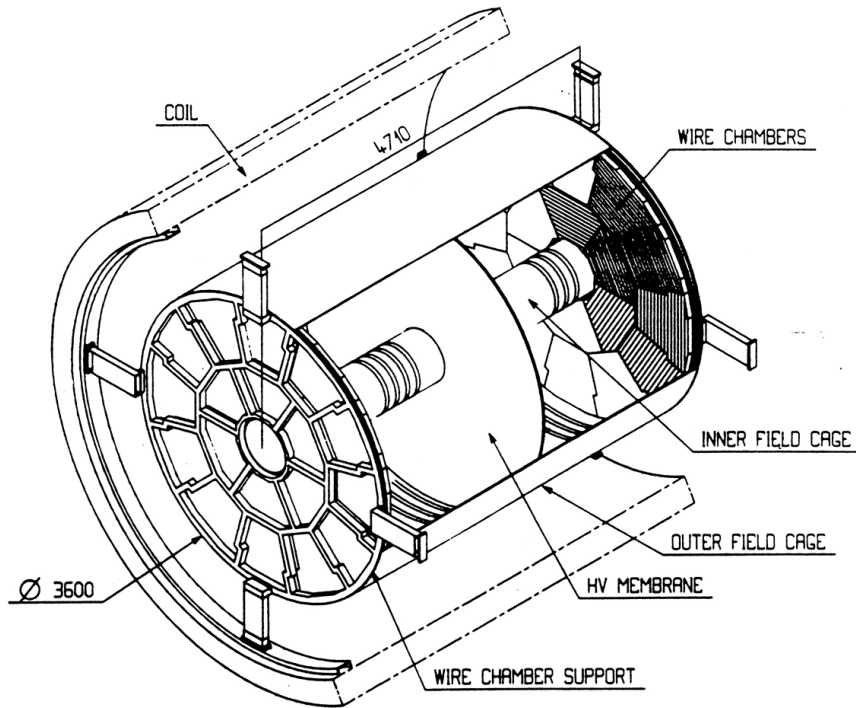
<https://www.star.bnl.gov/public/tpc/hard/tpcrings/page11.html>

https://flc.desy.de/tpc/basics/gem/index_eng.html

Thank you !

Back up

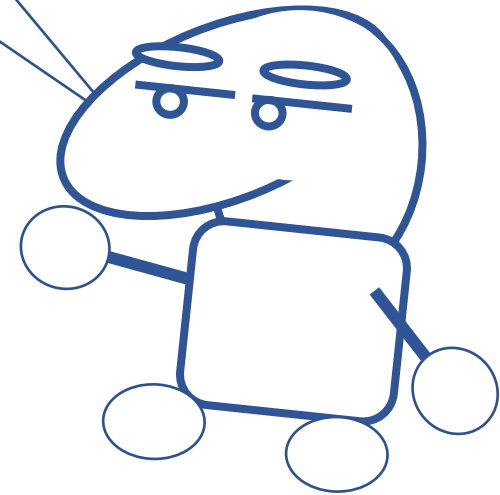
TPC = MWPC + Drift Chamber + TOF



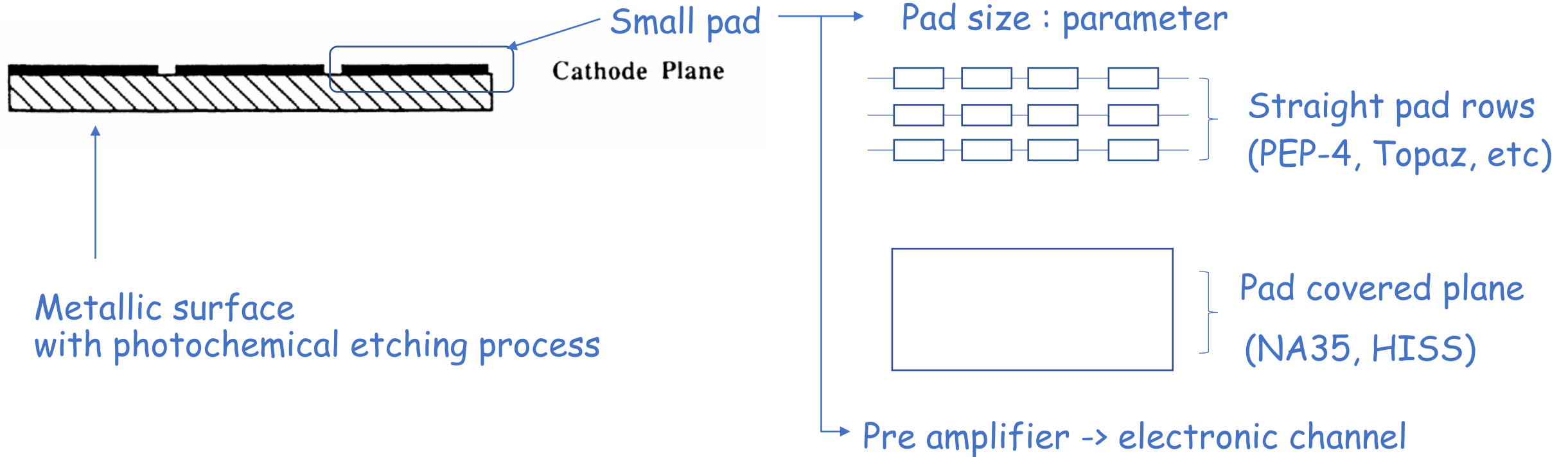
Watch this
video

<https://www.youtube.com/watch?v=vSbKxy7QF8I>

https://www.youtube.com/watch?v=R5G1_hW0ZUA

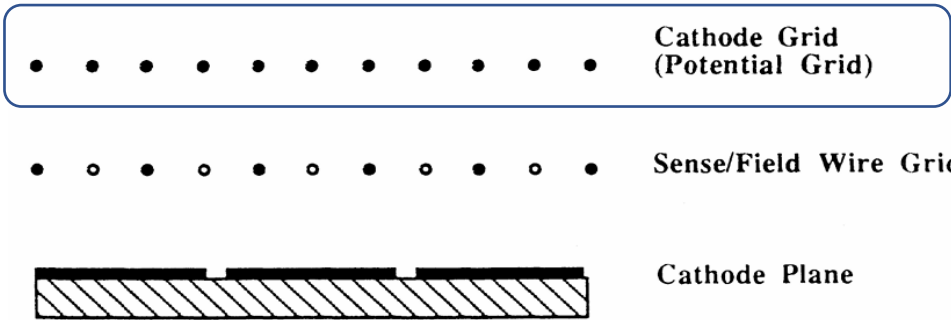


Wire Chamber

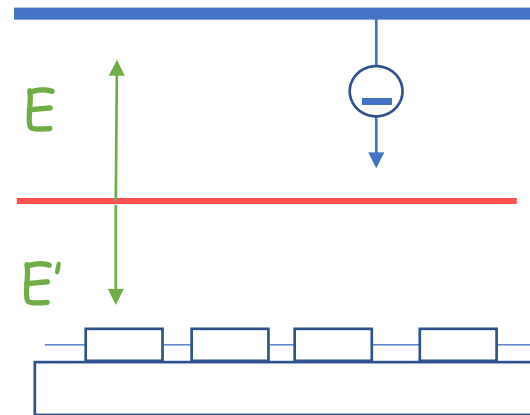


Wire Chamber

Null potential or cathode (-)



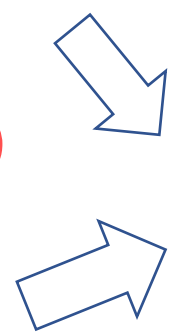
Drift Volume



Sense wire (+)

Cathode plane

Same Potential
 $E=E'$



GEM

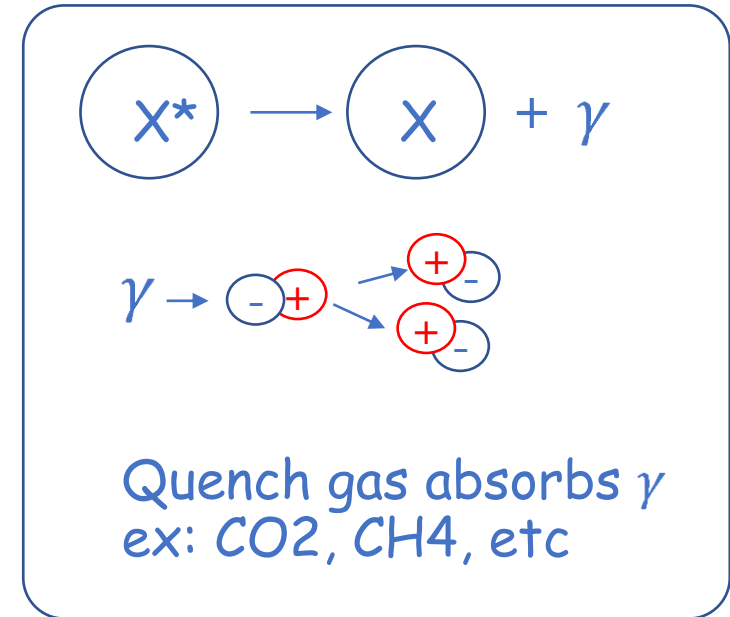
Table 1. Parameters of the upgraded TPC.

Detector gas	Ne-CO ₂ -N ₂ (90-10-5)
Gas volume	88 m ³
Drift voltage	100 kV
Drift field	400 V cm ⁻¹
Maximal drift length	250 cm
Electron drift velocity	2.58 cm μs ⁻¹
Maximum electron drift time	97 μs
$\omega\tau$ ($B = 0.5$ T)	0.32
Electron diffusion coefficients	$D_T = 209 \mu\text{m}/\sqrt{\text{cm}}$, $D_L = 221 \mu\text{m}/\sqrt{\text{cm}}$
Ion drift velocity	1.168 cm ms ⁻¹
Maximum ion drift time	214 ms

GEM

Table 1. Parameters of the upgraded TPC.

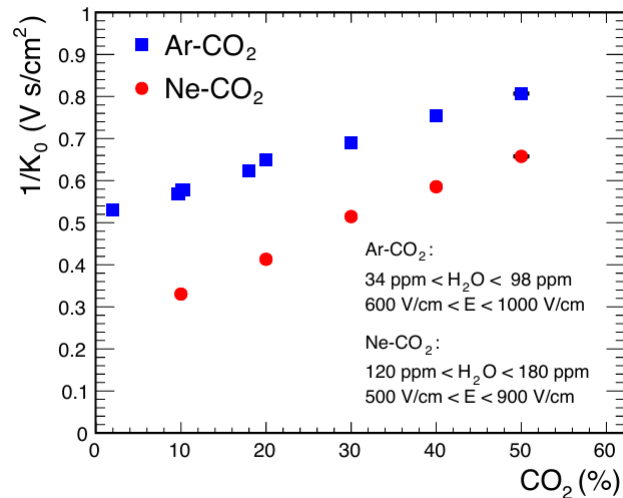
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Maximal drift length	250 cm
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Electron diffusion coefficients	$D_T = 209 \mu\text{m}/\sqrt{\text{cm}}, D_L = 221 \mu\text{m}/\sqrt{\text{cm}}$
Ion drift velocity	1.168 cm ms ⁻¹
Maximum ion drift time	214 ms



GEM

Table 2. Ionization and electron transport properties of a few gas mixtures used in modern TPCs, as calculated with the Magboltz [14] and Garfield [15] packages for an electric field of 400 V cm^{-1} .

Gas	Eff. ionization	Number of electrons per MIP		Drift velocity	Diffusion coeff.		
	energy W_i (eV)	N_p (primary) (e cm^{-1})	N_t (total) (e cm^{-1})	v_d ($\text{cm } \mu\text{s}^{-1}$)	D_L ($\mu\text{m}/\sqrt{\text{cm}}$)	D_T ($\mu\text{m}/\sqrt{\text{cm}}$)	$\omega\tau$
Ne-CO ₂ -N ₂ (90-10-5)	37.3	14.0	36.1	2.58	221	209	0.32
Ne-CO ₂ (90-10)	38.1	13.3	36.8	2.73	231	208	0.34
Ar-CO ₂ (90-10)	28.8	26.4	74.8	3.31	262	221	0.43
Ne-CF ₄ (80-20)	37.3	20.5	54.1	8.41	131	111	1.84



$$[\mu] = \text{cm}^2 / (\text{V} \cdot \text{s})$$

GEM

Readout chambers

Total number	$2 \times 2 \times 18 = 72$
Readout technology	4-GEM stack, single mask, standard (S, 140 μm) and large (LP, 280 μm) hole pitch GEMs in S-LP-LP-S configuration
Effective gas gain	2000

Inner (IROC)

Total number	$2 \times 18 = 36$
Active range	$848.5 < r < 1321 \text{ mm}$
Pad rows	63
Total pads (IROC)	5280
S:N (MIP)	20:1

Outer (OROC)

Total number	$2 \times 18 = 36$
Active range	$1347 < r < 2464 \text{ mm}$
Total pads (OROC)	9280
S:N (MIP)	30:1
Pad rows	89

OROC 1

Active range	$1347 < r < 1687 \text{ mm}$
Pad rows	34
Number of pads	2880

OROC 2

Active range	$1708 < r < 2068 \text{ mm}$
Pad rows	30
Number of pads	3200

OROC 3

Active range	$2089 < r < 2464 \text{ mm}$
Pad rows	25
Number of pads	3200

Readout electronics

Number of channels	524160
Signal polarity	negative
Average system noise (ENC)	$670 e$
Conversion gain	20 mV fC^{-1}
Dynamic range	100 fC
Peaking time	160 ns
ADC number of bits	10
ADC sampling rate	5 MHz
Power consumption (total)	56 mW per channel

GEM

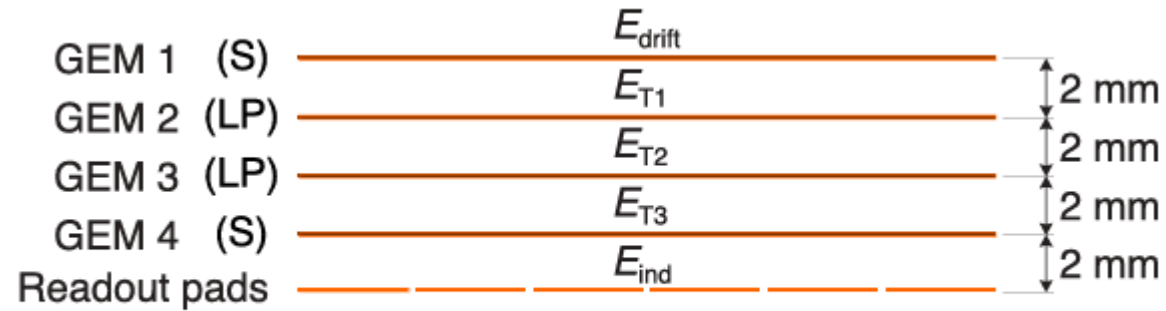


Figure 2. Schematic setup with four GEMs.

Table 8. HV test settings used for ROC quality assurance.

$\Delta V_{\text{GEM 1}}$	=	270 V
$\Delta V_{\text{GEM 2}}$	=	230 V
$\Delta V_{\text{GEM 3}}$	=	288 V
$\Delta V_{\text{GEM 4}}$	=	359 V
E_{drift}	=	400 V cm^{-1}
E_{T1}	=	4000 V cm^{-1}
E_{T2}	=	4000 V cm^{-1}
E_{T3}	=	100 V cm^{-1}
E_{ind}	=	4000 V cm^{-1}

GEM

